P-Channel 12 V (D-S) MOSFET

PRODUCT SUMMARY			
V_{DS} (V)	$R_{DS(on)}$ (Ω) Max.	I_D (A)	Q_g (Typ.)
- 12	0.640 at V_{GS} = - 4.5 V	- 0.48	1.15 nC
	0.880 at V_{GS} = - 2.5 V	- 0.41	
	1.200 at V_{GS} = - 1.8 V	- 0.35	
	1.443 at V_{GS} = - 1.5 V	- 0.10	
	2.475 at V_{GS} = - 1.2 V	- 0.05	

FEATURES

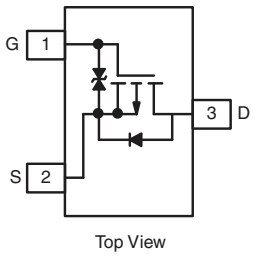
- TrenchFET® Power MOSFET
- Typical ESD protection: 700 V (HBM)
- Fast Switching Speed
- Material categorization:
  For definitions of compliance please see www.vishay.com/doc?99912

Pb-free
RoHS COMPLIANT
HALOGEN FREE

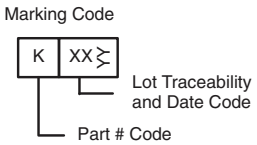
APPLICATIONS

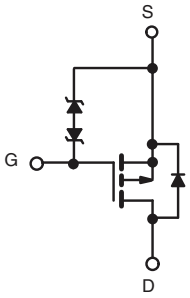
- Portable Devices such as Smart Phones, Tablet PCs and Mobile Computing
  - Load Switch for Low Voltage Gate Drive
  - Load Switch for 1.2 V Power Line

SC-89 (3-LEADS)



Top View





P-Channel MOSFET

Ordering Information: Si1011X-T1-GE3 (Lead (Pb)-free and Halogen-free)

ABSOLUTE MAXIMUM RATINGS (T_A = 25 °C, unless otherwise noted)				
Parameter		**Symbol**	**Limit**	**Unit**
Drain-Source Voltage		V_{DS}	- 12	V
Gate-Source Voltage		V_{GS}	± 5	
Continuous Drain Current (T_J = 150 °C)	T_A = 25 °C	I_D	- 0.48[b, c]	A
	T_A = 70 °C		- 0.38[b, c]	
Pulsed Drain Current (t = 300 µs)		I_{DM}	- 1.5	
Continuous Source-Drain Diode Current	T_A = 25 °C	I_S	- 0.16[b, c]	
Maximum Power Dissipation	T_A = 25 °C	P_D	0.19[b, c]	W
	T_A = 70 °C		0.12[b, c]	
Operating Junction and Storage Temperature Range		T_J, T_{stg}	- 55 to 150	°C

THERMAL RESISTANCE RATINGS					
Parameter		**Symbol**	**Typical**	**Maximum**	**Unit**
Maximum Junction-to-Ambient[a, b]	t ≤ 5 s	R_{thJA}	440	530	°C/W
	Steady State		540	650	

Notes:
a. Maximum under steady state conditions is 650 °C/W.
b. Surface mounted on 1" x 1" FR4 board.
c. t = 5 s.

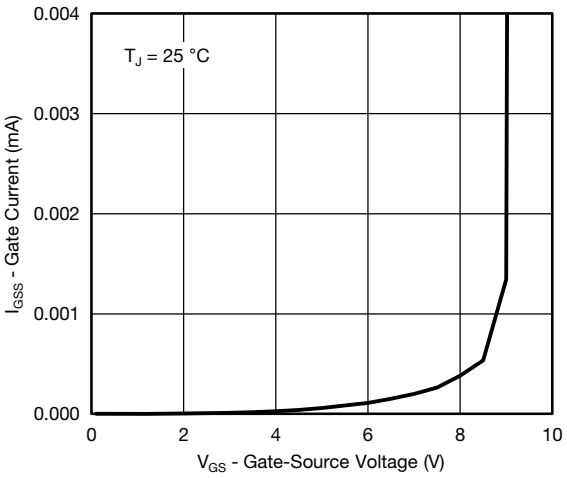
SPECIFICATIONS (T_J = 25 °C, unless otherwise noted)						
Parameter	**Symbol**	**Test Conditions**	**Min.**	**Typ.**	**Max.**	**Unit**
Static						
Drain-Source Breakdown Voltage	V_{DS}	V_{GS} = 0, I_D = - 250 µA	- 12			V
V_{DS} Temperature Coefficient	$\Delta V_{DS}/T_J$	I_D = - 250 µA		- 7		mV/°C
$V_{GS(th)}$ Temperature Coefficient	$\Delta V_{GS(th)}/T_J$			1.7		
Gate-Source Threshold Voltage	$V_{GS(th)}$	V_{DS} = V_{GS}, I_D = - 250 µA	- 0.35		- 0.8	V
Gate-Source Leakage	I_{GSS}	V_{DS} = 0 V, V_{GS} = ± 5 V			± 10	µA
		V_{DS} = 0 V, V_{GS} = ± 4.5 V			± 1	
Zero Gate Voltage Drain Current	I_{DSS}	V_{DS} = - 12 V, V_{GS} = 0 V			- 1	
		V_{DS} = - 12 V, V_{GS} = 0 V, T_J = 85 °C			- 10	
On-State Drain Current[a]	$I_{D(on)}$	$V_{DS} \leq$ - 5 V, V_{GS} = - 4.5 V	- 1.5			A
Drain-Source On-State Resistance[a]	$R_{DS(on)}$	V_{GS} = - 4.5 V, I_D = - 0.4 A		0.530	0.640	Ω
		V_{GS} = - 2.5 V, I_D = - 0.2 A		0.730	0.880	
		V_{GS} = - 1.8 V, I_D = - 0.1 A		0.920	1.200	
		V_{GS} = - 1.5 V, I_D = - 0.05 A		1.100	1.443	
		V_{GS} = - 1.2 V, I_D = - 0.05 A		1.650	2.475	
Forward Transconductance	g_{fs}	V_{DS} = - 6 V, I_D = - 0.4 A		1		S
Dynamic[b]						
Input Capacitance	C_{iss}	V_{DS} = - 6 V, V_{GS} = 0 V, f = 1 MHz		62		pF
Output Capacitance	C_{oss}			26		
Reverse Transfer Capacitance	C_{rss}			20		
Total Gate Charge	Q_g	V_{DS} = - 6 V, V_{GS} = - 4.5 V, I_D = - 0.4 A		2	4	nC
		V_{DS} = - 6 V, V_{GS} = - 2.5 V, I_D = - 0.4 A		1.15	2	
Gate-Source Charge	Q_{gs}			0.37		
Gate-Drain Charge	Q_{gd}			0.43		
Gate Resistance	R_g	f = 1 MHz		12		Ω
Turn-On Delay Time	$t_{d(on)}$	V_{DD} = - 6 V, R_L = 20 Ω $I_D \cong$ - 0.3 A, V_{GEN} = - 5 V, R_g = 1 Ω		4	8	ns
Rise Time	t_r			11	20	
Turn-Off DelayTime	$t_{d(off)}$			9	18	
Fall Time	t_f			9	18	
Drain-Source Body Diode Characteristics						
Pulse Diode Forward Current[a]	I_{SM}				- 1.5	A
Body Diode Voltage	V_{SD}	I_S = - 0.3 A		- 0.8	- 1.2	V
Body Diode Reverse Recovery Time	t_{rr}	I_F = - 0.3 A, dI/dt = 100 A/µs		12	20	ns
Body Diode Reverse Recovery Charge	Q_{rr}			5	10	nC
Reverse Recovery Fall Time	t_a			7		ns
Reverse Recovery Rise Time	t_b			5		

Notes:
a. Pulse test; pulse width ≤ 300 µs, duty cycle ≤ 2 %.
b. Guaranteed by design, not subject to production testing.

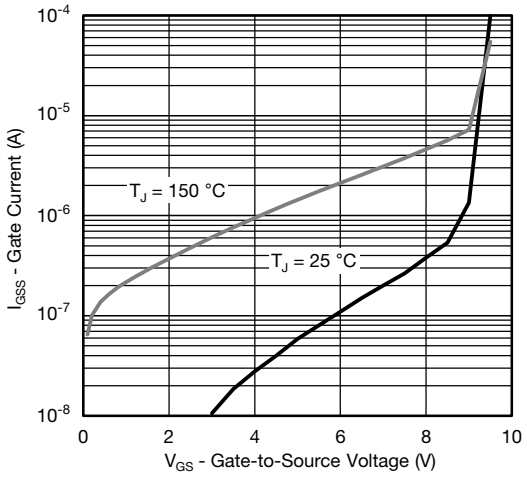
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

For technical questions, contact: pmostechsupport@vishay.com
Document Number: 62660
S12-2732-Rev. B, 12-Nov-12

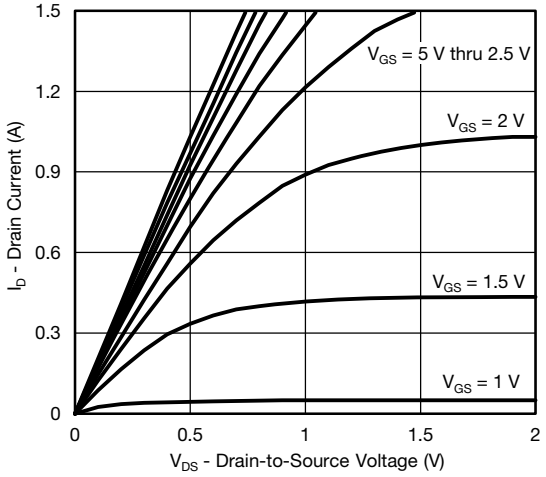
P-CHANNEL TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



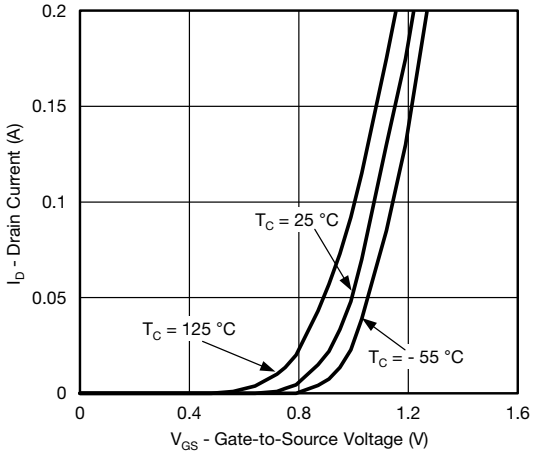
Gate Current vs. Gate-Source Voltage



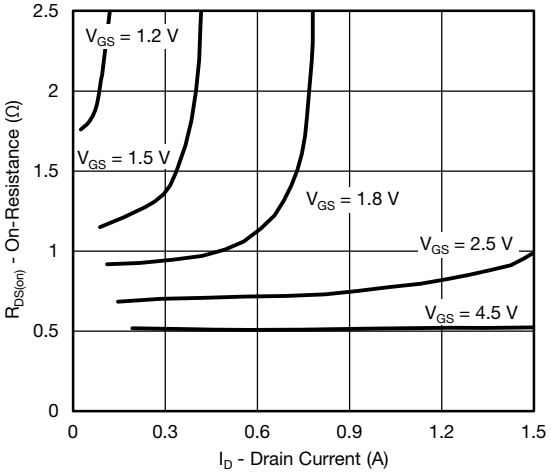
Gate Current vs. Gate-Source Voltage



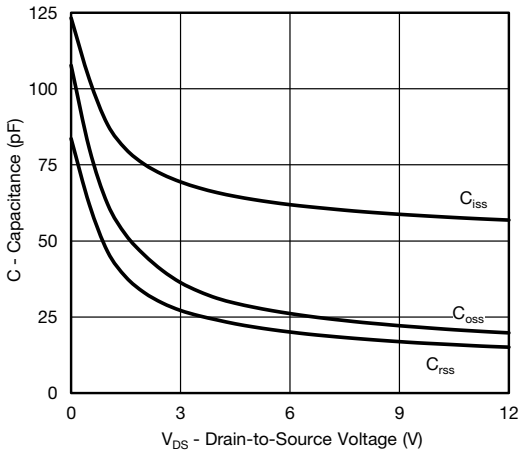
Output Characteristics



Transfer Characteristics

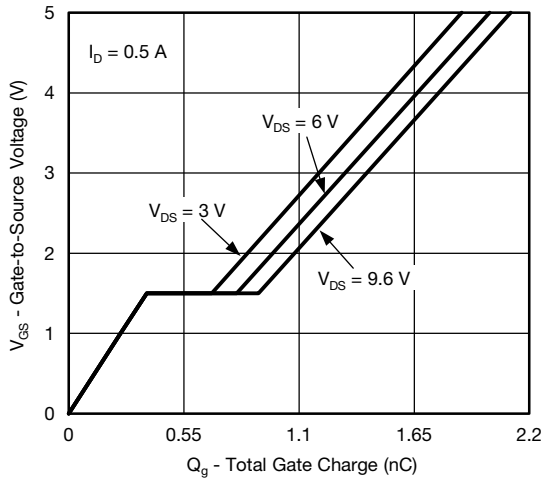


On-Resistance vs. Drain Current

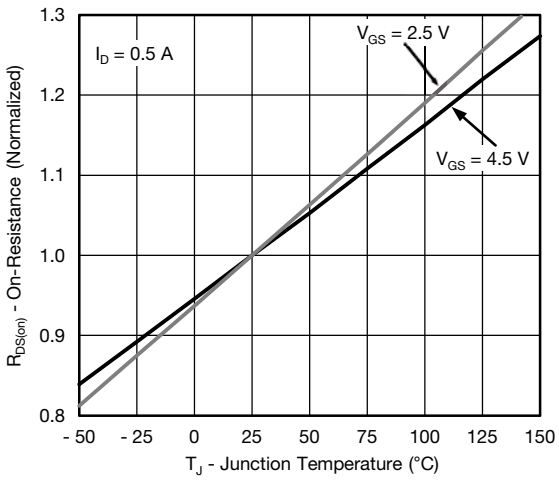


Capacitance

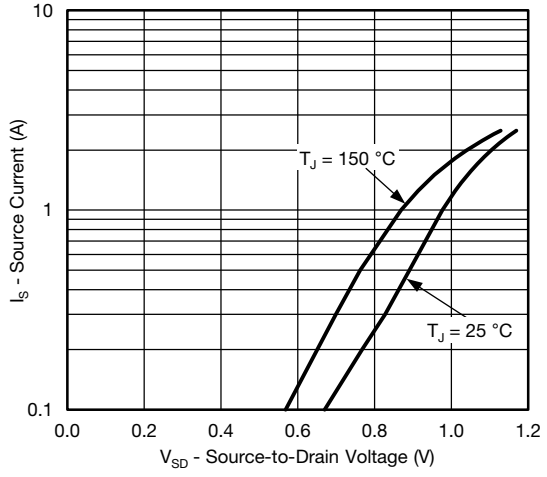
P-CHANNEL TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



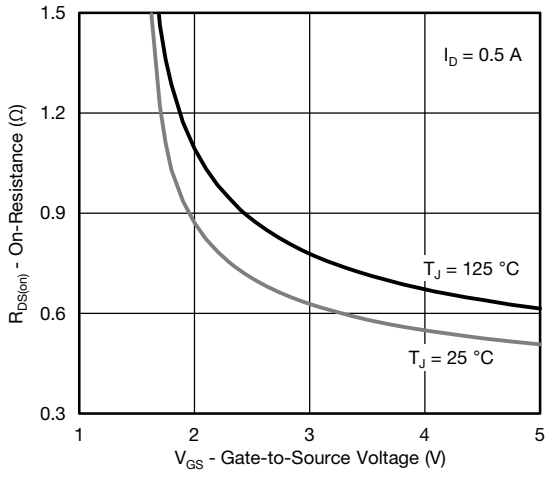
Gate Charge



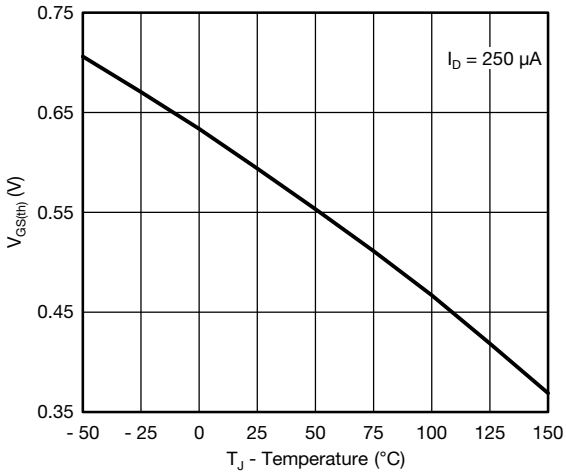
On-Resistance vs. Junction Temperature



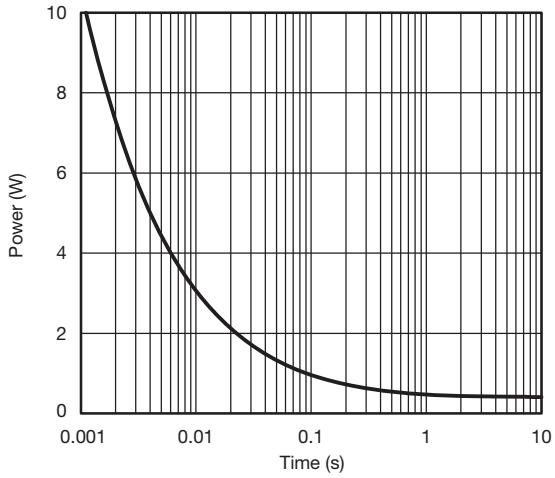
Source-Drain Diode Forward Voltage



On-Resistance vs. Gate-to-Source Voltage



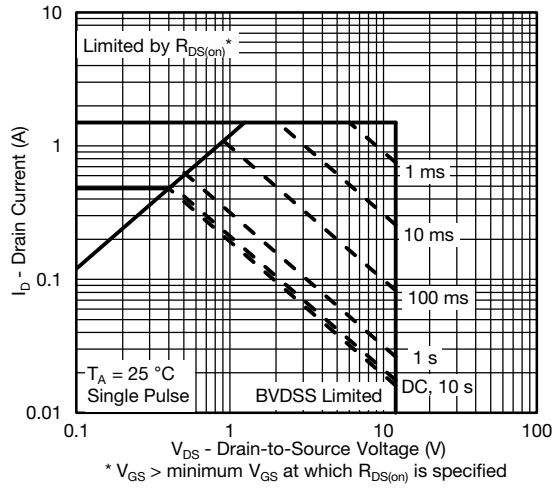
Threshold Voltage



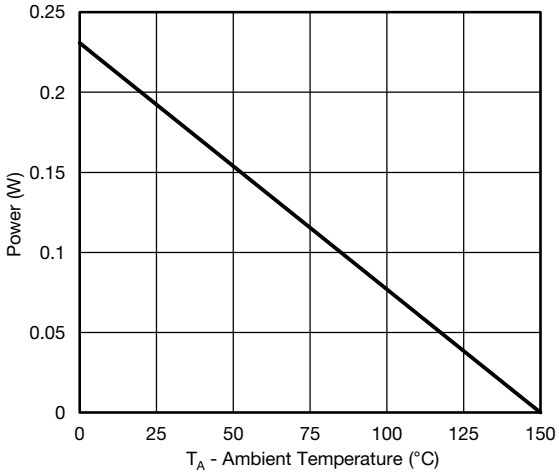
Single Pulse Power, Junction-to-Ambient

For technical questions, contact: pmostechsupport@vishay.com
Document Number: 62660
S12-2732-Rev. B, 12-Nov-12

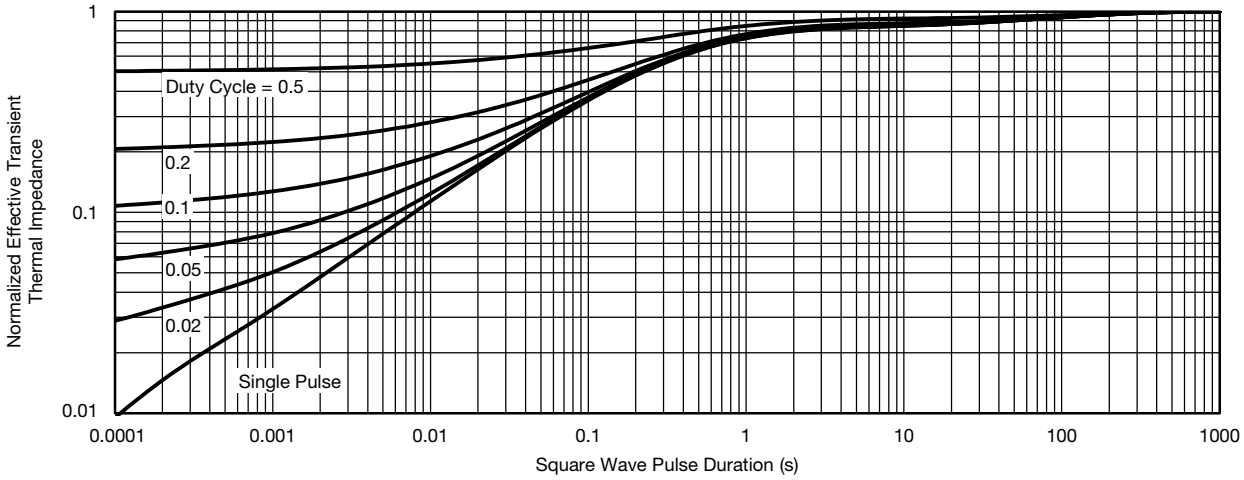
P-CHANNEL TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Safe Operating Area, Junction-to-Ambient



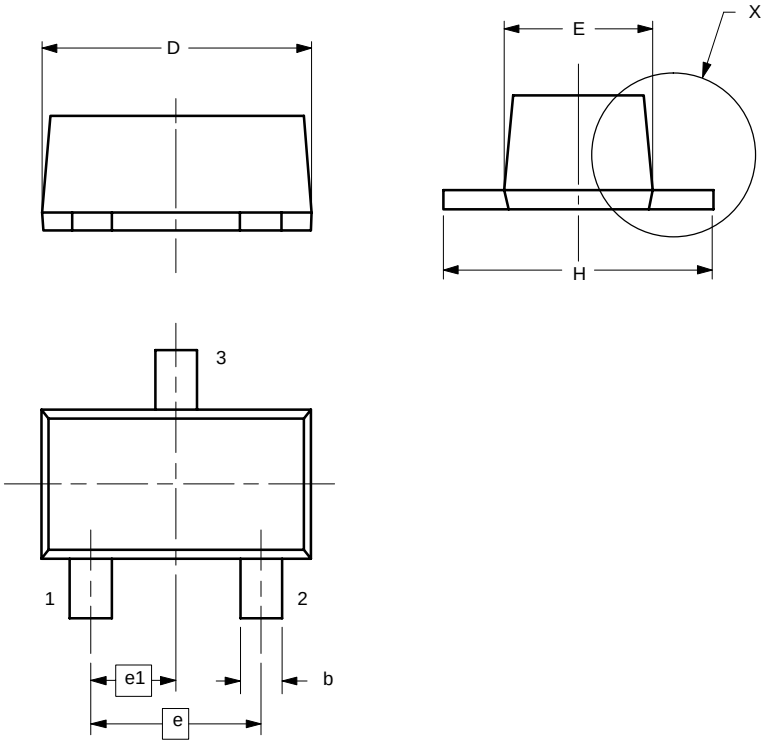
Power Derating, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Ambient

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg?62660.

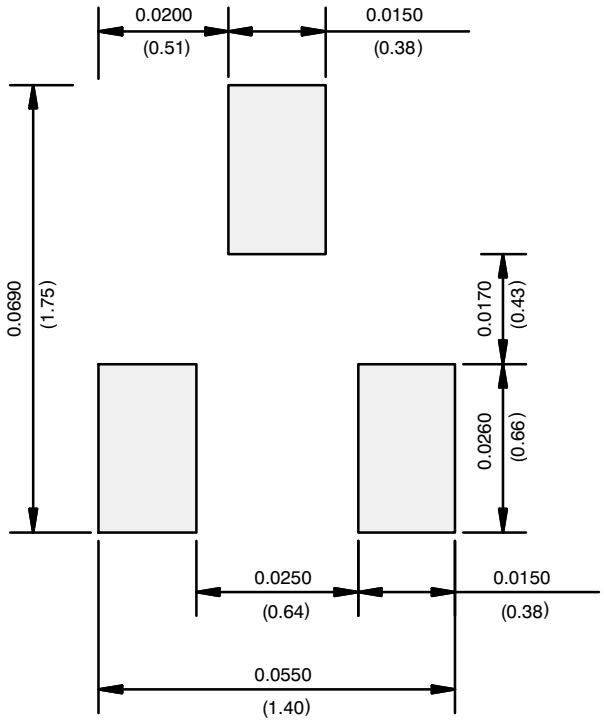
SC89-3



Dim	MILLIMETERS		INCHES	
	Min	Max	Min	Max
A	0.60	0.80	0.024	0.031
b	0.23	0.33	0.009	0.013
C	0.10	0.20	0.004	0.008
D	1.50	1.70	0.059	0.067
E	0.75	0.95	0.030	0.037
e	1.00 BSC		0.040 BSC	
e_1	0.50 BSC		0.020 BSC	
H	1.50	1.70	0.059	0.067
L	0.30	0.50	0.012	0.020

ECN: S-03946—Rev. B, 09-Jul-01
DWG: 5869

RECOMMENDED MINIMUM PADS FOR SC-89: 3-Lead



Recommended Minimum Pads
Dimensions in Inches/(mm)

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